



### • General Description

It combines trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

### • Features

- AEC-Q101 Qualified
- Low  $R_{DS(ON)}$  to minimize conductive loss
- High GOX reliability
- Low Thermal resistance

### • Application

- BLDC Motor driver
- DC-DC
- Load Switch

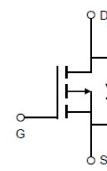
### • Ordering Information:

Part NO.	ZMA950P04T1
Marking	950P04
Packing Information	REEL TAPE
Basic ordering unit (pcs)	3000

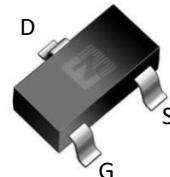
### • Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ , unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Max.	Unit
Drain-Source Voltage	$V_{DS}$		-	-40	V
Gate-Source Voltage	$V_{GS}$		-20	20	V
Continuous Drain Current	$I_D$	$V_{GS}=-10\text{V}, T_A=25^\circ\text{C}$	-	-1.8	A
	$I_D$	$V_{GS}=-10\text{V}, T_A=75^\circ\text{C}$	-	-1.4	A
	$I_D$	$V_{GS}=-10\text{V}, T_A=100^\circ\text{C}$	-	-1.1	A
Pulsed Drain Current	$I_{DM}$	Pulsed; $t_p \leqslant 10\ \mu\text{s}; T_A = 25^\circ\text{C}$	-	-7.2	A
Total Power Dissipation	$P_D$	$T_A=25^\circ\text{C}(t \leqslant 10\text{s})$	-	0.6	W
Total Power Dissipation	$P_D$	$T_A=25^\circ\text{C}$ (Steady-state)	-	0.4	W
Operating Junction Temperature	$T_J$		-55	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$		-55	150	$^\circ\text{C}$
Single Pulse Avalanche Energy	$E_{AS}$	$L=0.1\text{mH}, V_{GS}=-10\text{V}, R_g=25\Omega,$	-	7.2	mJ
		$L=0.5\text{mH}, V_{GS}=-10\text{V}, R_g=25\Omega,$	-	13.0	mJ
ESD Level (HBM)				CLASS 1B	

### • Product Summary



$V_{DS} = -40\text{V}$   
 $R_{DS(ON)} = 96\text{m}\Omega$   
 $I_D = -1.8\text{A}$



SOT-23-3





## ● Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction-ambient <sup>①</sup>	R <sub>thJA</sub> (t≤10s)	-	-	220	°C/W
Thermal resistance, junction-ambient <sup>①</sup>	R <sub>thJA</sub> (Steady-state)	-	-	300	°C/W
Soldering temperature	T <sub>sold</sub>	-	-	260	°C

● Electronic Characteristics (T<sub>j</sub>=25°C, unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-40	-	-	V
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250μA, T <sub>j</sub> =25°C	-1.3	-2	-2.5	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =-40V, T <sub>j</sub> =25°C	-	-	1.0	uA
		V <sub>GS</sub> =0V, V <sub>DS</sub> =-40V, T <sub>j</sub> =150°C	-	-	100	uA
Gate- Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> = 0V	-	-	100	nA
Static Drain-source On Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.5A, T <sub>j</sub> =25°C	-	96	115	mΩ
		V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.5A, T <sub>j</sub> =150°C	-	154	-	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1A, T <sub>j</sub> =25°C	-	152	200	mΩ
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1A, T <sub>j</sub> =150°C	-	228	-	mΩ
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> = -1.5A	-	2.7	-	S
Diode Forward Voltage	V <sub>FSD</sub>	V <sub>GS</sub> =0V, I <sub>SD</sub> = -1.5A	-	-	-1.3	V

● Dynamic characteristics (T<sub>j</sub>=25°C, unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	C <sub>iss</sub>	f = 1MHz, V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V	-	391	-	pF
Output capacitance	C <sub>oss</sub>		-	33	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	22	-	
Gate Resistance	R <sub>g</sub>	f = 1MHz, V <sub>GS</sub> =0V	-	17	-	Ω
Total gate charge	Q <sub>g</sub>	V <sub>DD</sub> = -20V, I <sub>D</sub> = -1.5A, V <sub>GS</sub> = -10V	-	6.8	-	nC
	Q <sub>g</sub> (-4.5V)		-	3.2	-	
Gate - Source charge	Q <sub>gs</sub>		-	1.9	-	
Gate - Drain charge	Q <sub>gd</sub>		-	0.8	-	
Turn-ON Delay time	t <sub>D(on)</sub>	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, R <sub>G</sub> =3.3Ω, I <sub>D</sub> =-1.5A	-	3.2	-	ns
Turn-ON Rise time	t <sub>r</sub>		-	18.7	-	ns
Turn-Off Delay time	t <sub>D(off)</sub>		-	16.9	-	ns
Turn-Off Fall time	t <sub>f</sub>		-	22.5	-	ns
Reverse Recovery Time	t <sub>rr</sub>	V <sub>DD</sub> =-20V, dI <sub>S</sub> /dt = 100A/us, I <sub>S</sub> =-1.5A	-	11	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		-	6	-	nC



Fig.1 Gate-source voltage as a function of gate charge;Typical values;Tj=25°C

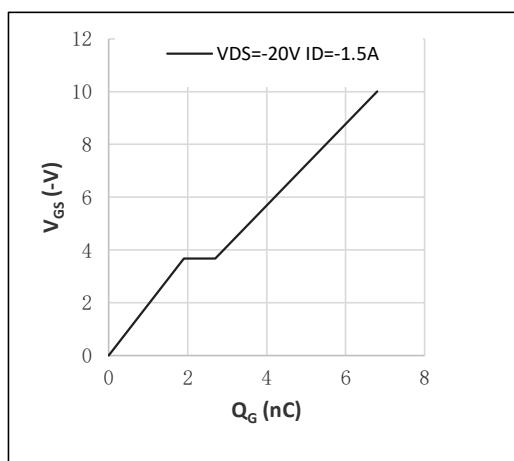


Fig.3 Output characteristics: drain current as a function of drain-source voltage;Typical values;Tj=25°C

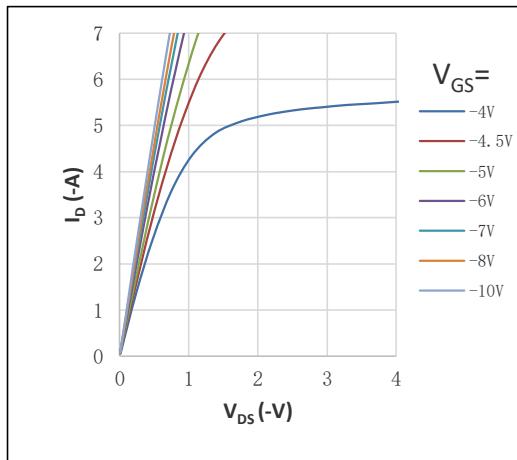


Fig.5 Gate-source threshold voltage as a function of junction temperature;Typical values

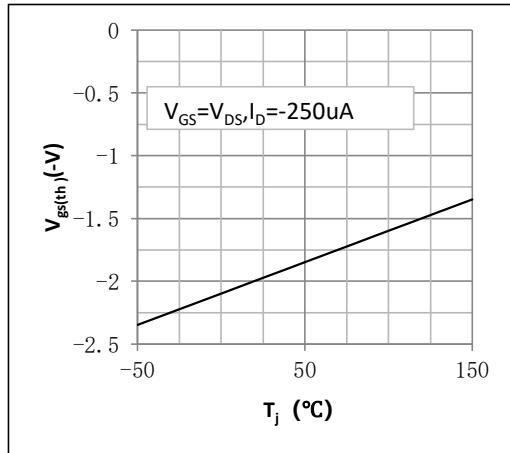


Fig.2 Input, output and reverse transfer capacitances as a function of drain-source voltage;Typical values;Tj=25°C

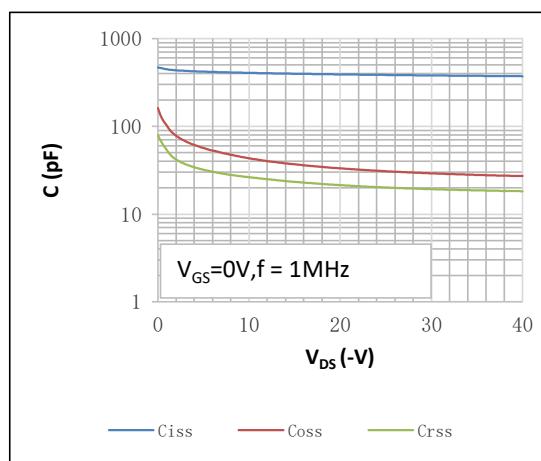


Fig.4 Output characteristics: drain current as a function of drain-source voltage;Typical values;Expanded curve;Tj=25°C

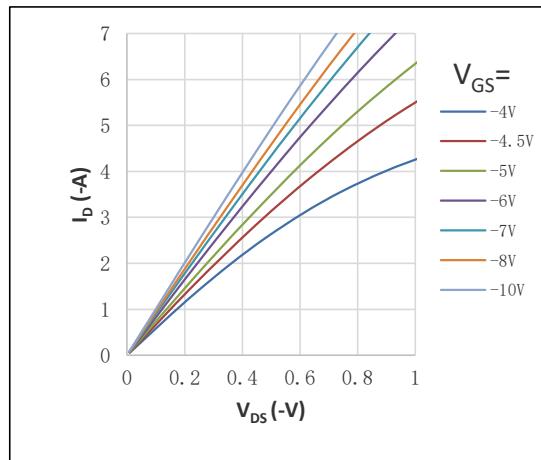


Fig.6 Drain-source on-state resistance as a function of drain current;Typical values;Tj=25°C

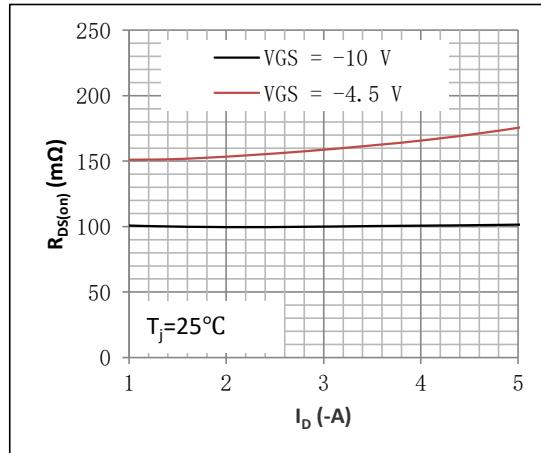


Fig.7 Drain-source on-state resistance as a function of gate-source voltage;Typical values

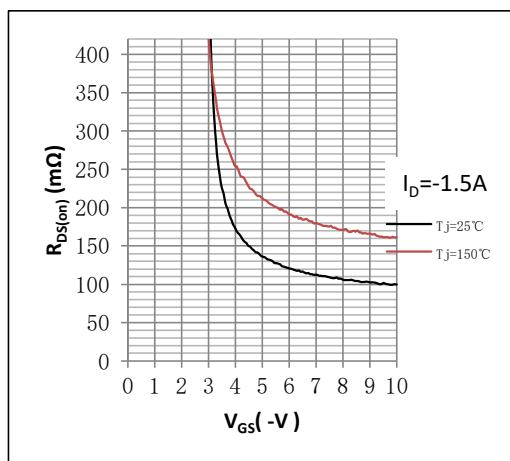


Figure 9. Source (diode forward) current as a function of source-drain (diode forward) voltage ;Typical values

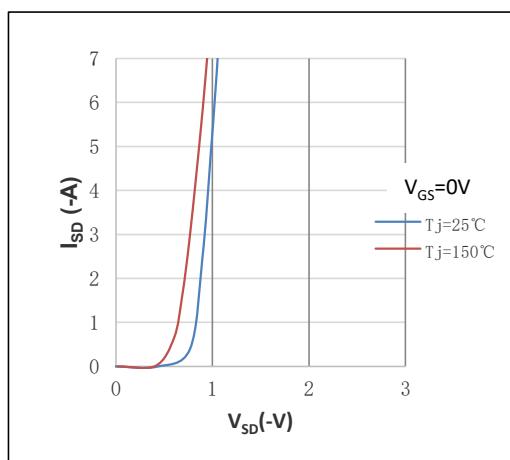


Fig.11 Safe operating area: continuous and peak drain currents as a function of drain-source voltage;Calculative values

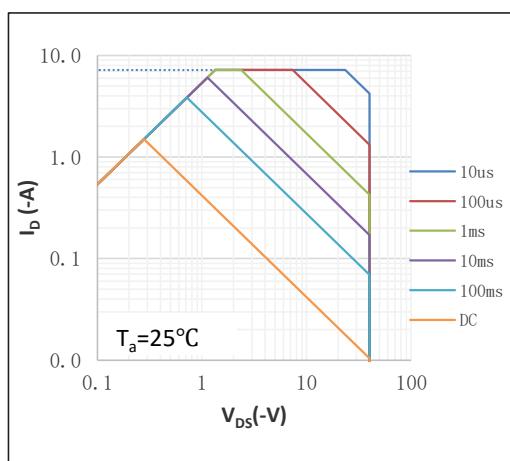


Fig.8 Normalized drain-source on-state resistance factor as a function of junction temperature;Typical values  
Normalized On-Resistance=RDSon/RDSon(25 °C)

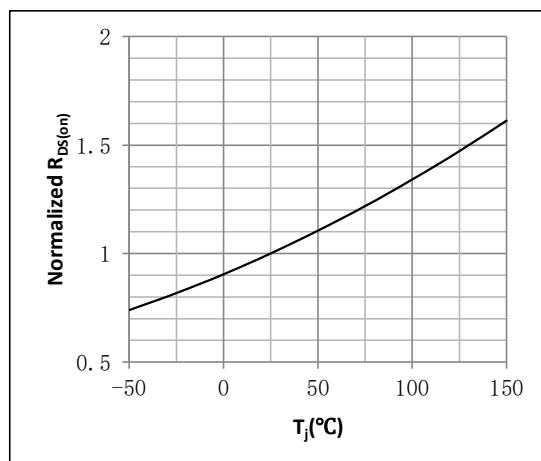


Figure 10. Transfer characteristics: drain current as a function of gate-source voltage;Typical values

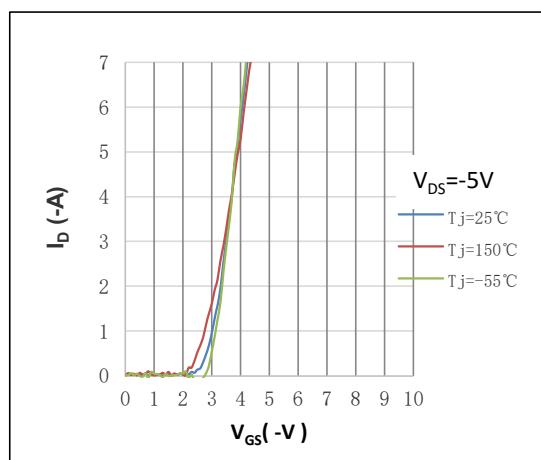


Fig.12 Continuous drain current as a function of ambient temperature<sup>①</sup>;Calculative values

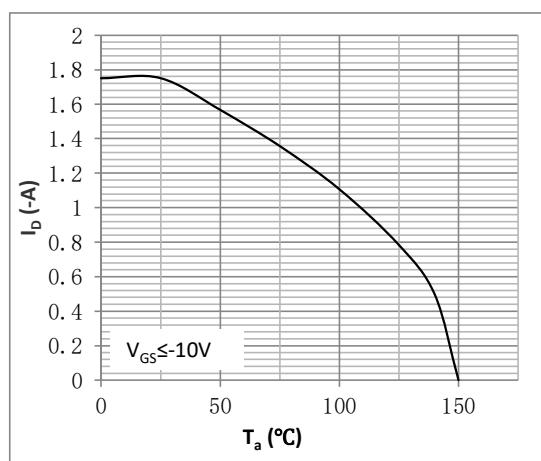


Fig.13 Drain-source breakdown voltage as a function of junction temperature;Typical values  
Normalized BVDSS= BVDSS/BVDSS(25°C)

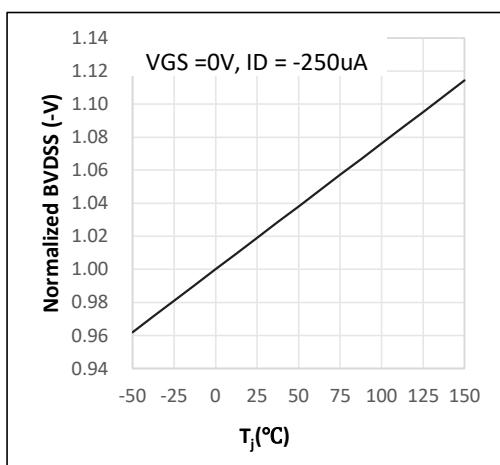


Fig.14 Normalized total power dissipation as a function of ambient temperature;Calculative values Normalized Power Dissipation=  $P_d/P_d(25^\circ\text{C})$

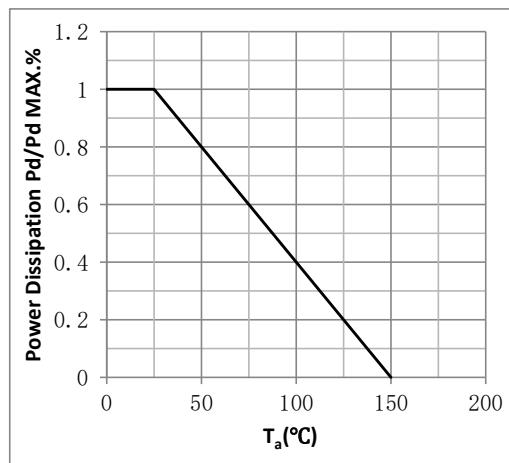
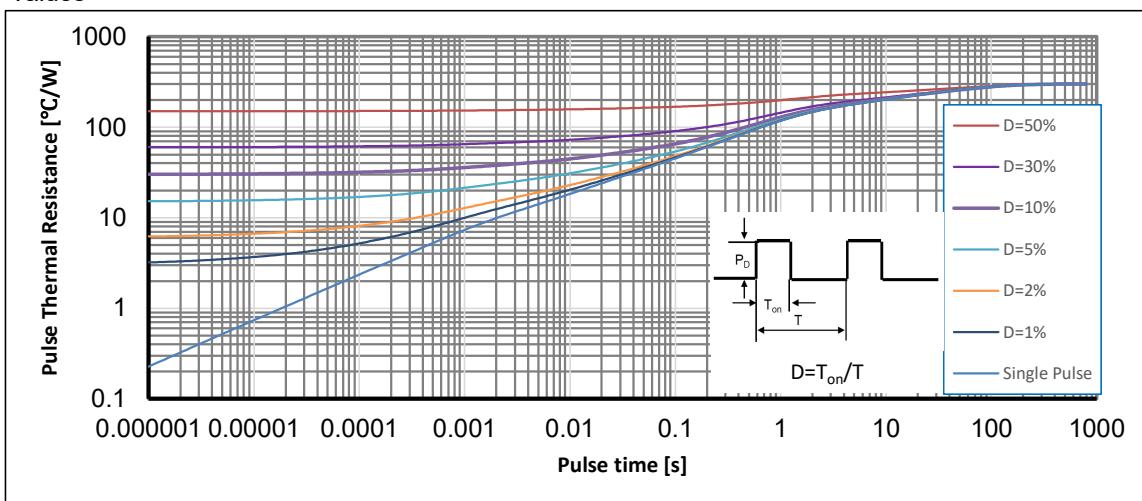
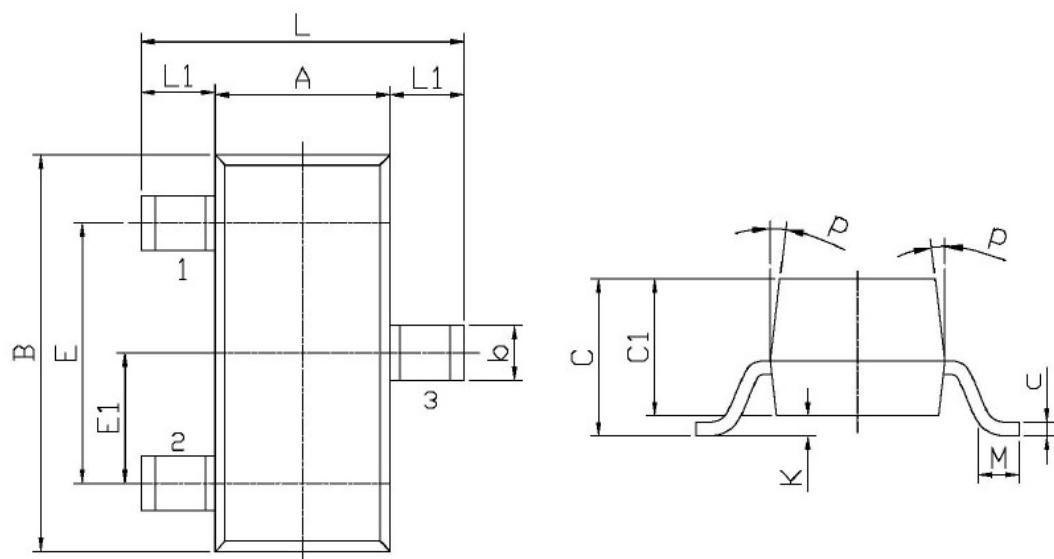


Fig.15 Transient thermal impedance from junction to ambient as a function of pulse duration; max values





## •SOT-23-3 Package Outline



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20
A	1.15	1.50	c	0.05	0.20
B	2.70	3.10	K	0	0.10
E	1.70	2.10	M	0.20MIN	
E1	0.85	1.05	P	7°	
b	0.35	0.55			

**Note:**

- ① Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ② Practically the current will be limited by PCB, thermal design and operating temperature. VGS=-10V.

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## Revision History

Version	Date	Change
Preliminary	2025/2/9	NEW